



54AC08

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SNOS079B-JULY 2003-REVISED APRIL 2013

54AC08 Quad 2-Input AND Gate

Check for Samples: 54AC08

FEATURES

DESCRIPTION

The 'AC08 contains four, 2-input AND gates.

- I_{CC} Reduced by 50%
- Outputs Source/Sink 24 mA
- Standard Microcircuit Drawing (SMD) 5962-87615
- 54AC08 now Qualified to 300Krad RHA Designation, Refer to the SMD for More Information
- For Military 54ACT08 Device, see 54ACTQ08

Logic Symbol

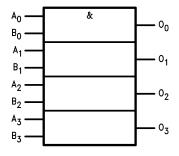


Figure 1. IEEE/IEC

Connection Diagrams

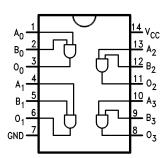


Figure 2. 14-Pin CDIP or CLGA See J or NAD0014B Package

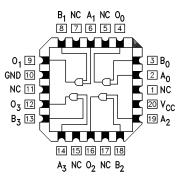


Figure 3. 20-Pin LCCC See NAJ0020A Package

| Pin Names | Description |
|---------------------------------|-------------|
| A _n , B _n | Inputs |
| On | Outputs |

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾⁽²⁾

| Supply Voltage (V _{CC}) | | -0.5V to +7.0V |
|---|----------------------------------|---------------------------------|
| | $V_1 = -0.5V$ | -20 mA |
| DC Input Diode Current (I _{IK}) | $V_{I} = V_{CC} + 0.5V$ | +20 mA |
| DC Input Voltage (VI) | | -0.5V to V _{CC} + 0.5V |
| | $V_{O} = -0.5V$ | −20 mA |
| DC Output Diode Current (I _{OK}) | $V_{\rm O} = V_{\rm CC} + 0.5 V$ | +20 mA |
| DC Output Voltage (V _O) | | -0.5V to V _{CC} + 0.5V |
| DC Output Source or Sink Current (I _O) | | ±50 mA |
| DC V_{CC} or Ground Current per Output Pin (I _{CC} | ±50 mA | |
| Storage Temperature (T _{STG}) | | −65°C to +150°C |
| Junction Temperature (T _J) | CDIP | 175°C |

(1) Absolute Maximum Ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. TI does not recommend operation of FACT[™] circuits outside databook specifications.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

Recommended Operating Conditions

| Supply Voltage (V _{CC}) | 'AC | 2.0V to 6.0V | |
|---|--|-----------------------|--|
| Input Voltage (V _I) | | 0V to V_{CC} | |
| Output Voltage (V _O) | | 0V to V _{CC} | |
| Operating Temperature (T _A) | 54AC | −55°C to +125°C | |
| Minimum Input Edge Rate ($\Delta V/\Delta t$) 'AC | $V_{\rm IN}$ from 30% to 70% of $V_{\rm CC}$ | 125 mV/ns | |
| Devices | V _{CC} @ 3.3V, 4.5V, 5.5V | 125 117/115 | |



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DC Characteristics for 'AC Family Devices

| | | | 54AC | | |
|------------------|------------------------|------------------------|----------------------------------|-------|--|
| Symbol | Parameter | V _{CC} (V) | T _A = −55°C to +125°C | Units | Conditions |
| | | (•) | Ensured Limits | | |
| V _{IH} | Minimum High Level | 3.0 | 2.1 | | $V_{OUT} = 0.1 V$ |
| | Input Voltage | 4.5 | 3.15 | V | or V_{CC} – 0.1V |
| | | 5.5 | 3.85 | | |
| VIL | Maximum Low Level | 3.0 | 0.9 | | $V_{OUT} = 0.1 V$ |
| | Input Voltage | 4.5 | 1.35 | V | or V _{CC} – 0.1V |
| | | 5.5 | 1.65 | | |
| V _{OH} | Minimum High Level | 3.0 | 2.9 | | I _{OUT} = -50 μA |
| | Output Voltage | 4.5 | 4.4 | V | |
| | | 5.5 | 5.4 | | |
| | | | | | $V_{IN} = V_{IL} \text{ or } V_{IH}^{(1)}$ |
| | | 3.0 | 2.4 | | -12 mA |
| | | 4.5 | 3.7 | V | I _{OH} −24 mA |
| | | 5.5 | 4.7 | | -24 mA |
| V _{OL} | Maximum Low Level | 3.0 | 0.1 | | I _{OUT} = 50 μA |
| | Output Voltage | 4.5 | 0.1 | V | |
| | | 5.5 | 0.1 | | |
| | | | | | $V_{IN} = V_{IL} \text{ or } V_{IH}^{(1)}$ |
| | | 3.0 | 0.5 | | 12 mA |
| | | 4.5 | 0.5 | V | I _{OL} 24 mA |
| | | 5.5 | 0.5 | | 24 mA |
| I _{IN} | Maximum Input | 5.5 | ±1.0 | μA | $V_{I} = V_{CC}, GND$ |
| | Leakage Current | | | | |
| I _{OLD} | Minimum Dynamic Output | 5.5 | 50 | mA | V _{OLD} = 1.65V Max |
| I _{OHD} | Current ⁽²⁾ | 5.5 | -50 | mA | V _{OHD} = 3.85V Min |
| I _{CC} | Maximum Quiescent | 5.5 | 40.0 | μA | $V_{IN} = V_{CC}$ |
| | Supply Current | | | | or GND |

(1) All outputs loaded; thresholds on input associated with output under test.(2) Maximum test duration 2.0 ms, one output loaded at a time.

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AC Electrical Characteristics

| | | | 54AC T _A = -55°C to +125°C, C _L = 50 pF | | | |
|------------------|-------------------|------------------------------------|--|------|-------|----------|
| Symbol | Parameter | V _{CC} (V) ⁽¹⁾ | | | Units | Fig. No. |
| | | | Min | Max | | |
| t _{PLH} | Propagation Delay | 3.3 | 1.0 | 12.5 | ns | |
| | | 5.0 | 1.0 | 9.0 | | |
| t _{PHL} | Propagation Delay | 3.3 | 1.0 | 12.5 | ns | |
| | | 5.0 | 1.0 | 9.0 | | |

(1) Voltage Range 3.3 is $3.3V \pm 0.3V$. Voltage Range 5.0 is $5.0V \pm 0.5V$.

Table 1. Capacitance

| Symbol | Parameter | Тур | Units | Conditions |
|-----------------|----------------------------------|------|-------|------------------|
| C _{IN} | Input Capacitance | 4.5 | pF | $V_{CC} = OPEN$ |
| C _{PD} | Power Dissipation Capacitance | 20.0 | pF | $V_{CC} = 5.0 V$ |



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REVISION HISTORY

| Changes | from | Revision | Δ | (An | ril | 2013) | to | Revision B | 2 |
|---------|------|-----------|---|-----|-----|-------|----|-------------------|---|
| Changes | nom | VEA121011 | A | (AP | | 2013) | ω | VEA121011 D | , |

| • C | Changed layout of National Data Sheet to TI format 4 |
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|-----|--|

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